



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	Rds(on)	I _D T _A = 25°C
60V	2Ω @ V _{GS} = 10V	540mA
807	3Ω @ V _{GS} = 5V	430mA

Description and Applications

This new generation MOSFET has been designed to minimize the on-state resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

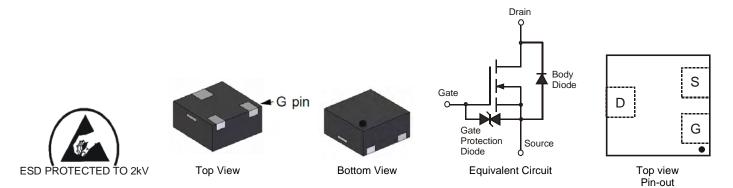
- DC-DC Converters
- Power management functions
- Battery Operated Systems and Solid-State Relays
- Load switch

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate to 2kV
- Lead Free/RoHS Compliant (Note 1)
- Green Device (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: X1-DFN1212-3
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
- Terminals: Finish NiPdAu over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Weight: 0.005 grams (approximate)



Ordering Information (Note 3)

Part Number	Case	Packaging
DMN62D0SFD-7	X1-DFN1212-3	3000/Tape & Reel

Notes: 1. No purposefully added lead.

2. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com

3. For packaging details, go to our website at http://www.diodes.com

Marking Information



K62 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Y = 2011) M = Month (ex: 9 = September)

Date Code Key

Date Code hoy													
Year	20	07	20	2008		2009		2010		2011		2012	
Code	l	J	١	V	W		Х		Y		Z		
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec	
Code	1	2	3	4	5	6	7	8	9	0	N	D	



Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Units		
Drain-Source Voltage		V _{DSS}	60	V	
Gate-Source Voltage			V _{GSS}	±20	V
	Steady State	T _A = 25°C T _A = 70°C	ID	540 430	mA
Continuous Drain Current (Note 5) V_{GS} = 10V	t<10s	T _A = 25°C T _A = 70°C	ID	630 500	mA
Continuous Drain Current (Note 5) \/ 5\/	Steady State	T _A = 25°C T _A = 70°C	ID	430 340	mA
Continuous Drain Current (Note 5) $V_{GS} = 5V$	t<10s	T _A = 25°C T _A = 70°C	ID	510 410	mA
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	I _{DM}	1.0	A		
Maximum Body Diode Forward Current (Note 5)	ls	1.0	А		

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 4)		PD	0.43	W
Thermal Desistance, Junction to Ambient (Note 4)	Steady state	P	260	°C/W
Thermal Resistance, Junction to Ambient (Note 4)	t<10s	$R_{ extsf{ heta}JA}$	182	°C/W
Total Power Dissipation (Note 5)		PD	0.89	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	D	140	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{ extsf{ heta}JA}$	98	°C/W
Thermal Resistance, Junction to Case (Note 5)		$R_{\theta JC}$	112	°C/W
Operating and Storage Temperature Range		T _{J.} T _{STG}	-55 to +150	°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

						-	
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV _{DSS}	60	-	-	V	$V_{GS} = 0V, I_D = 10\mu A$	
Zero Gate Voltage Drain Current $T_J = 25^{\circ}C$	I _{DSS}	-	-	100	nA	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	-	-	10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(th)}	1.0	1.6	2.5	V	$V_{DS} = 10V, I_{D} = 1mA$	
Static Drain-Source On-Resistance		-	-	2	Ω	$V_{GS} = 10V, I_D = 500mA$	
	R _{DS (ON)}	-	-	3	52	$V_{GS} = 5V$, $I_D = 50mA$	
Forward Transfer Admittance	Y _{fs}	-	130	-	mS	$V_{DS} = 3V, I_{D} = 30mA$	
Diode Forward Voltage	V _{SD}	-	0.8	1.2	V	$V_{GS} = 0V, I_{S} = 300 \text{mA}$	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	Ciss	-	30.2	-	pF		
Output Capacitance	Coss	-	4.4	-	pF	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	-	2.8	-	pF		
Gate Resistance	Rg	-	131	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Qg	-	0.39	-	nC		
Total Gate Charge (V _{GS} = 10.0V)	Qg	-	0.87	-	nC	$V_{DS} = 10V, I_{D} = 1A$	
Gate-Source Charge	Q _{gs}	-	0.14	-	nC	$V_{DS} = 10V, ID = 1A$	
Gate-Drain Charge	Q _{gd}	-	0.09	-	nC	<u>] </u>	
Turn-On Delay Time	t _{D(on)}	-	3.95	-	ns		
Turn-On Rise Time	tr	-	3.81	-	ns	$V_{DS} = 30V, I_{D} = 200mA$	
Turn-Off Delay Time	t _{D(off)}	-	16.0	-	ns	V_{GS} = 10V, R_G = 25 Ω	
Turn-Off Fall Time	t _f	-	9.04	-	ns		

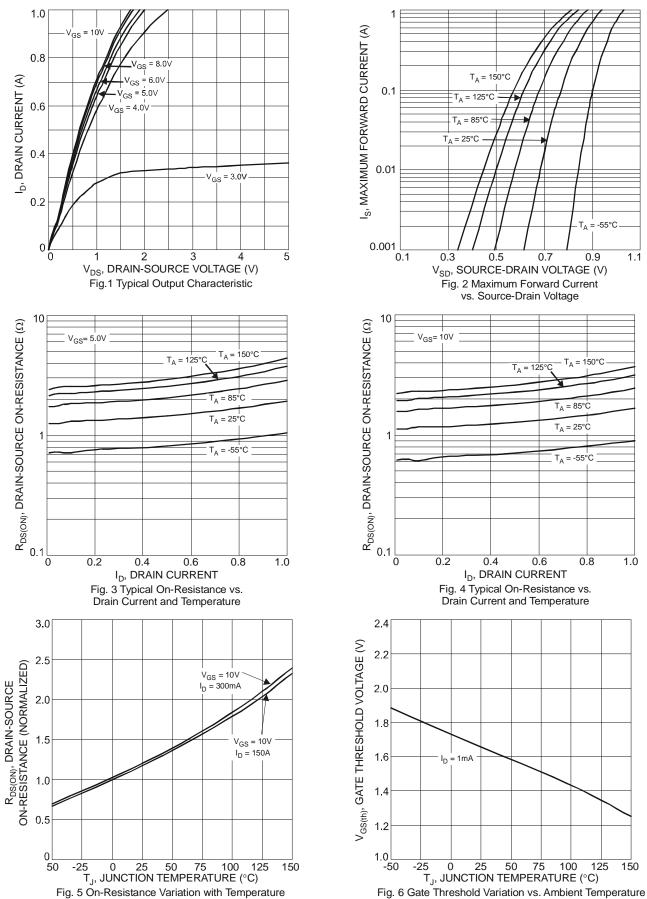
Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate
Short duration pulse test used to minimize self-heating effect.

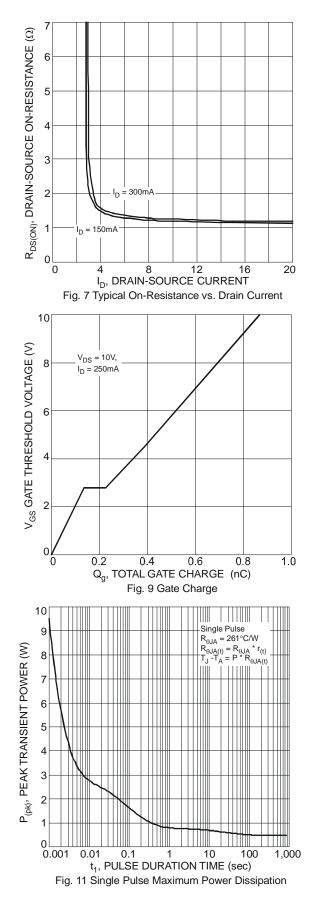
7. Guaranteed by design. Not subject to production testing.

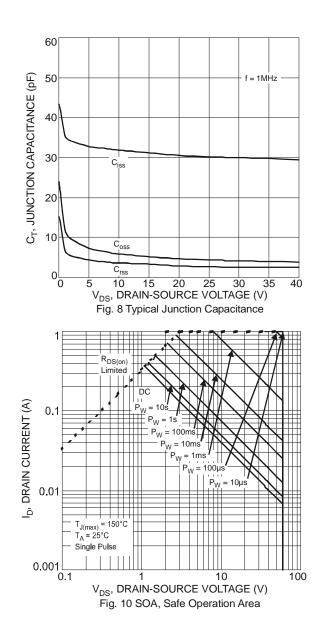
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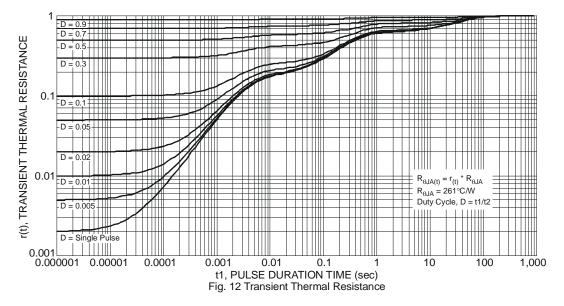




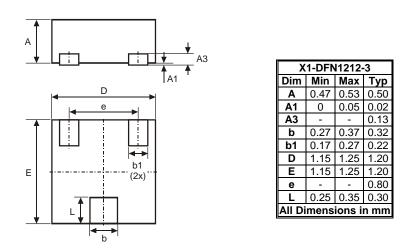




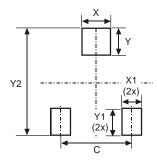




Package Outline Dimensions



Suggested Pad Layout



Dimensions	Value (in mm)
С	0.80
Х	0.42
X1	0.32
Y	0.50
Y1	0.50
Y2	1.50



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